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In re application of :

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Shinji KAJII et al.

Confirmation No. 8610

Serial No. 10/634,829

[Group Art Unit 1755

Filed August 6, 2003

Examiner Karl E. Group]

HIGHLY HEAT-RESISTANT INORGANIC FIBER BONDED CERAMIC COMPONENT AND PROCESS FOR THE PRODUCTION THEREOF

COMMENTS ON STATEMENT OF REASONS FOR ALLOWANCE

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

The Notice of Allowability states as the Reasons for Allowance that,

"The prior art of record fails to teach or fairly suggest the claimed inorganic fiber bonded composite of a specific surface structure and having carbon containing grain boundaries of 1-100 nm."

In reply, the above feature is already described at U.S. 6,132,856 and JP No. 9-52776 having a filing date of August 17, 1995.

A partial translation of JP No. 9-52776 A is enclosed.

A revised Statement of Reasons for Allowance is, accordingly, respectfully requested.

Respectfully submitted,

Shinji KAJII et al.

THE COMMISSIONER IS AUTHORIZED TO CHARGE ANY DEFICIENCY IN THE FEES FOR THIS PAPER TO DEPOSIT ACCOUNT NO. 23-0975

Matthew M. Jacob

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